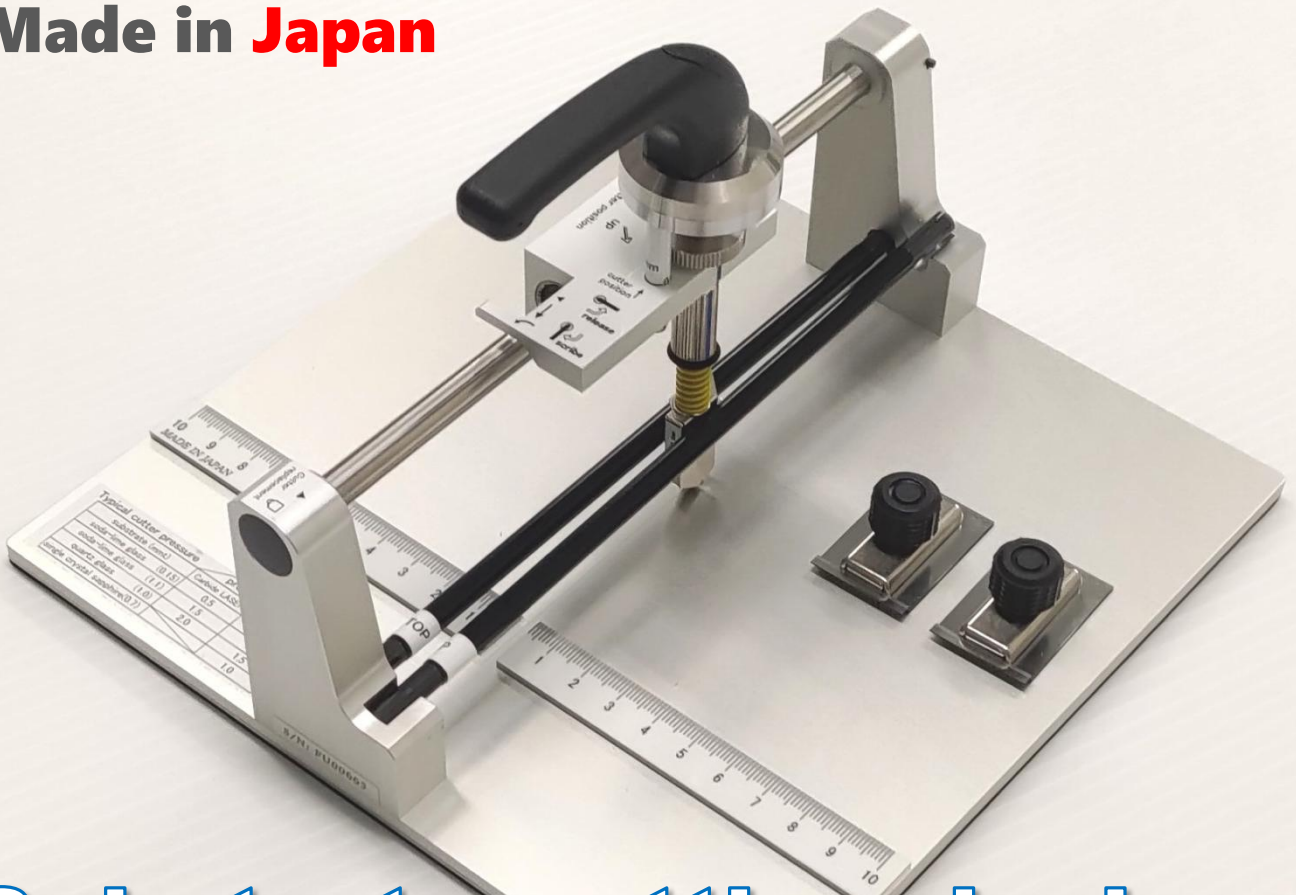


Made in Japan



Substrate cutting device **KARATE Groover**

It can be split by making a cut with a rotating blade.
Please create your own collection Plates.

《 Feature points 》

1. Easy to operate.
2. Dimension control.
3. Applicable to glass, silicon and sapphire.




It can be broken cleanly
with light force.

See the video for details



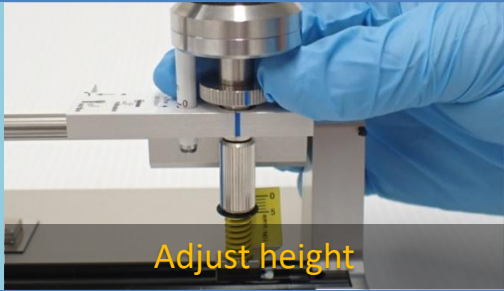
How to use KARATE Groover

1




Set the sample

2



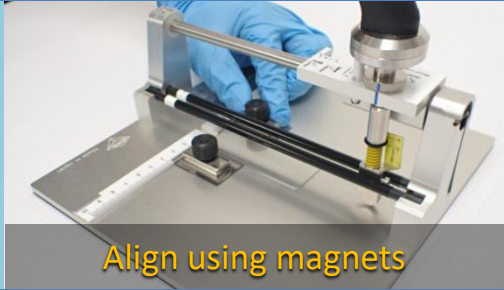
Adjust height

3




Pressure regulation

4



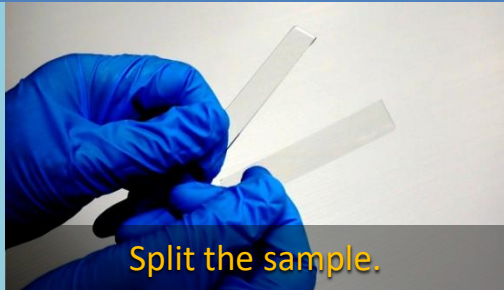
Align using magnets

5

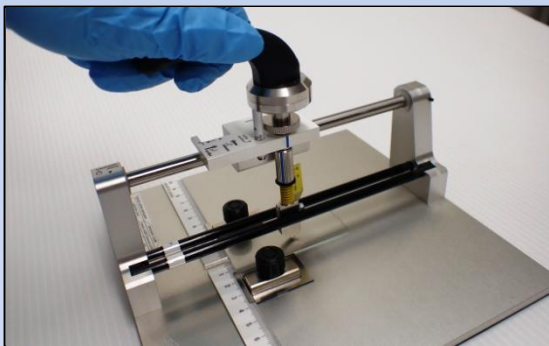


Draw a groove with a tool

6



Split the sample.



Set height, pressure and position, and just by pulling lightly on the surface. grooves are created.



Stable positioning is possible with the attached magnet Plate guide.

Body dimensions	210×210×136mm
Standard cutting thickness	0.1mm~2.0mm
Maximum cut length	115mm
Weight	1.37kg
Magnet Plate guide	25×35mm (ground surface rubber)



SYNTEK CO., LTD.



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